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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	13
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	36 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 6V
Data Converters	A/D 4x8b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	18-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c71-04i-so

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3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC16CXX family can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC16CXX uses a Harvard architecture, in which, program and data are accessed from separate memories using separate buses. This improves bandwidth over traditional von Neumann architecture in which program and data are fetched from the same memory using the same bus. Separating program and data buses further allows instructions to be sized differently than the 8-bit wide data word. Instruction opcodes are 14-bits wide making it possible to have all single word instructions. A 14-bit wide program memory access bus fetches a 14-bit instruction in a single cycle. A twostage pipeline overlaps fetch and execution of instructions (Example 3-1). Consequently, all instructions (35) execute in a single cycle (200 ns @ 20 MHz) except for program branches.

The table below lists program memory (EPROM) and data memory (RAM) for each PIC16C71X device.

Device	Program Memory	Data Memory
PIC16C710	512 x 14	36 x 8
PIC16C71	1K x 14	36 x 8
PIC16C711	1K x 14	68 x 8
PIC16C715	2K x 14	128 x 8

The PIC16CXX can directly or indirectly address its register files or data memory. All special function registers, including the program counter, are mapped in the data memory. The PIC16CXX has an orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any addressing mode. This symmetrical nature and lack of 'special optimal situations' make programming with the PIC16CXX simple yet efficient. In addition, the learning curve is reduced significantly.

PIC16CXX devices contain an 8-bit ALU and working register. The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between the data in the working register and any register file.

The ALU is 8-bits wide and capable of addition, subtraction, shift and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature. In two-operand instructions, typically one operand is the working register (W register). The other operand is a file register or an immediate constant. In single operand instructions, the operand is either the W register or a file register.

The W register is an 8-bit working register used for ALU operations. It is not an addressable register.

Depending on the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. The C and DC bits operate as a borrow bit and a digit borrow out bit, respectively, in subtraction. See the SUBLW and SUBWF instructions for examples.

FIGURE 4-5: PIC16C711 REGISTER FILE MAP



FIGURE 4-6: PIC16C715 REGISTER FILE MAP

File Address	3		File Address				
00h	INDF ⁽¹⁾	INDF ⁽¹⁾	80h				
01h	TMR0	OPTION					
02h	PCL	PCL					
03h	STATUS	STATUS	83h				
04h	FSR	FSR					
05h	PORTA	TRISA					
06h	PORTB	TRISB					
07h			87h				
08h			88h				
09h			89h				
0Ah	PCLATH	PCLATH	8Ah				
0Bh	INTCON	INTCON	8Bh				
0Ch	PIR1	PIE1	8Ch				
0Dh			8Dh				
0Eh		PCON	8Eh				
0Fh			8Fh				
10h							
11h							
12h							
13h			 93h				
14h							
15h			95h				
16h			96h				
17h			97h				
18h							
19h							
1Ah			9Ah				
1Bh			9Bh				
1Ch			9Ch				
1Dh			9Dh				
1Eh	ADRES		9Eh				
1Fh	ADCON0	ADCON1					
20h	General Purpose	General Purpose	A0h				
	Register	Register	BFh				
			Con				
7Fh	Bank 0	Bank 1	_ FFh				
Unimplemented data memory locations, read as '0'. Note 1: Not a physical register.							

4.2.2.2 OPTION REGISTER

Applicable Devices 710 71 711 715

The OPTION register is a readable and writable register which contains various control bits to configure the TMR0/WDT prescaler, the External INT Interrupt, TMR0, and the weak pull-ups on PORTB.

FIGURE 4-8: OPTION REGISTER (ADDRESS 81h, 181h)

R/W-1	R/W-1	R/W-1 F	R/W-1 R/W-1	R/W-1	R/W-1	R/W-1	
RBPU bit7	INTEDG	TOCS	TOSE PSA	PS2	PS1	PS0 bit0	R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset
bit 7:	RBPU: PO 1 = PORTE 0 = PORTE	RTB Pull-up 3 pull-ups ai 3 pull-ups ai	o Enable bit re disabled re enabled by inc	lividual port	latch value	es	
bit 6:	INTEDG: In 1 = Interrup 0 = Interrup	nterrupt Edg ot on rising ot on falling	ge Select bit edge of RB0/INT edge of RB0/INT	[∙] pin Γpin			
bit 5:	TOCS: TMF 1 = Transiti 0 = Interna	R0 Clock Sc on on RA4/ I instruction	ource Select bit T0CKI pin cycle clock (CLł	(OUT)			
bit 4:	TOSE: TMF 1 = Increm 0 = Increm	R0 Source E ent on high- ent on low-t	Edge Select bit to-low transition o-high transition	on RA4/T0 on RA4/T0	CKI pin CKI pin		
bit 3:	PSA: Prese 1 = Presca 0 = Presca	caler Assigr ler is assigr ler is assigr	nment bit ned to the WDT ned to the Timer() module			
bit 2-0:	PS2:PS0:	Prescaler R	ate Select bits				
	Bit Value	TMR0 Rate	WDT Rate				
	000 001 010 011 100 101 110 111	1 : 2 1 : 4 1 : 8 1 : 16 1 : 32 1 : 64 1 : 128 1 : 256	1 : 1 1 : 2 1 : 4 1 : 8 1 : 16 1 : 32 1 : 64 1 : 128				

Note: To achieve a 1:1 prescaler assignment for the TMR0 register, assign the prescaler to the Watchdog Timer by setting bit PSA (OPTION<3>).

5.0 I/O PORTS

Applicable Devices 710 71 711 715

Some pins for these I/O ports are multiplexed with an alternate function for the peripheral features on the device. In general, when a peripheral is enabled, that pin may not be used as a general purpose I/O pin.

5.1 PORTA and TRISA Registers

PORTA is a 5-bit latch.

The RA4/T0CKI pin is a Schmitt Trigger input and an open drain output. All other RA port pins have TTL input levels and full CMOS output drivers. All pins have data direction bits (TRIS registers) which can configure these pins as output or input.

Setting a TRISA register bit puts the corresponding output driver in a hi-impedance mode. Clearing a bit in the TRISA register puts the contents of the output latch on the selected pin(s).

Reading the PORTA register reads the status of the pins whereas writing to it will write to the port latch. All write operations are read-modify-write operations. Therefore a write to a port implies that the port pins are read, this value is modified, and then written to the port data latch.

Pin RA4 is multiplexed with the Timer0 module clock input to become the RA4/T0CKI pin.

Other PORTA pins are multiplexed with analog inputs and analog VREF input. The operation of each pin is selected by clearing/setting the control bits in the ADCON1 register (A/D Control Register1).

Note:	On a Power-on Reset, these pins are con-
	figured as analog inputs and read as '0'.

The TRISA register controls the direction of the RA pins, even when they are being used as analog inputs. The user must ensure the bits in the TRISA register are maintained set when using them as analog inputs.

EXAMPLE 5-1: INITIALIZING PORTA



FIGURE 5-1: BLOCK DIAGRAM OF RA3:RA0 PINS



FIGURE 5-2: BLOCK DIAGRAM OF RA4/ T0CKI PIN



|--|

ТО	PD	
1	1	Power-on Reset
0	x	Illegal, TO is set on POR
x	0	Illegal, PD is set on POR
0	1	WDT Reset
0	0	WDT Wake-up
u	u	MCLR Reset during normal operation
1	0	MCLR Reset during SLEEP or interrupt wake-up from SLEEP

TABLE 8-8: STATUS BITS AND THEIR SIGNIFICANCE, PIC16C710/711

POR	BOR	TO	PD	
0	x	1	1	Power-on Reset
0	x	0	x	Illegal, TO is set on POR
0	x	x	0	Illegal, PD is set on POR
1	0	x	x	Brown-out Reset
1	1	0	1	WDT Reset
1	1	0	0	WDT Wake-up
1	1	u	u	MCLR Reset during normal operation
1	1	1	0	MCLR Reset during SLEEP or interrupt wake-up from SLEEP

TABLE 8-9: STATUS BITS AND THEIR SIGNIFICANCE, PIC16C715

PER	POR	BOR	TO	PD				
1	0	x	1	1	Power-on Reset			
x	0	x	0	x	Illegal, TO is set on POR			
x	0	x	x	0	Ilegal, PD is set on POR			
1	1	0	x	x	Brown-out Reset			
1	1	1	0	1	WDT Reset			
1	1	1	0	0	WDT Wake-up			
1	1	1	u	u	MCLR Reset during normal operation			
1	1	1	1	0	MCLR Reset during SLEEP or interrupt wake-up from SLEEP			
0	1	1	1	1	Parity Error Reset			
0	0	x	x	x	Illegal, PER is set on POR			
0	x	0	x	x	Illegal, PER is set on BOR			

Register	Power-on Reset, Brown-out Reset Parity Error Reset	MCLR Resets WDT Reset	Wake-up via WDT or Interrupt
W	xxxx xxxx	นนนน นนนน	นนนน นนนน
INDF	N/A	N/A	N/A
TMR0	xxxx xxxx	นนนน นนนน	นนนน นนนน
PCL	0000 0000	0000 0000	PC + 1 ⁽²⁾
STATUS	0001 1xxx	000q quuu ⁽³⁾	uuuq quuu ⁽³⁾
FSR	xxxx xxxx	นนนน นนนน	นนนน นนนน
PORTA	x 0000	u 0000	u uuuu
PORTB	xxxx xxxx	นนนน นนนน	นนนน นนนน
PCLATH	0 0000	0 0000	u uuuu
INTCON	0000 000x	0000 000u	uuuu uuuu (1)
PIR1	-0	-0	_u(1)
ADCON0	0000 00-0	0000 00-0	uuuu uu-u
OPTION	1111 1111	1111 1111	นนนน นนนน
TRISA	1 1111	1 1111	u uuuu
TRISB	1111 1111	1111 1111	นนนน นนนน
PIE1	-0	-0	-u
PCON	qqq	luu	luu
ADCON1	00	00	uu

TABLE 8-13: INITIALIZATION CONDITIONS FOR ALL REGISTERS, PIC16C715

Legend: u = unchanged, x = unknown, -= unimplemented bit, read as '0', q = value depends on condition Note 1: One or more bits in INTCON and PIR1 will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

3: See Table 8-11 for reset value for specific condition.

8.8 Power-down Mode (SLEEP)

Power-down mode is entered by executing a $\ensuremath{\mathtt{SLEEP}}$ instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the \overline{PD} bit (STATUS<3>) is cleared, the \overline{TO} (STATUS<4>) bit is set, and the oscillator driver is turned off. The I/O ports maintain the status they had, before the SLEEP instruction was executed (driving high, low, or hi-impedance).

For lowest current consumption in this mode, place all I/O pins at either VDD, or VSS, ensure no external circuitry is drawing current from the I/O pin, power-down the A/D, disable external clocks. Pull all I/O pins, that are hi-impedance inputs, high or low externally to avoid switching currents caused by floating inputs. The TOCKI input should also be at VDD or VSS for lowest current consumption. The contribution from on-chip pull-ups on PORTB should be considered.

The $\overline{\text{MCLR}}$ pin must be at a logic high level (VIHMC).

8.8.1 WAKE-UP FROM SLEEP

The device can wake up from SLEEP through one of the following events:

- 1. External reset input on $\overline{\text{MCLR}}$ pin.
- 2. Watchdog Timer Wake-up (if WDT was enabled).
- 3. Interrupt from INT pin, RB port change, or some Peripheral Interrupts.

External $\overline{\text{MCLR}}$ Reset will cause a device reset. All other events are considered a continuation of program execution and cause a "wake-up". The $\overline{\text{TO}}$ and $\overline{\text{PD}}$ bits in the STATUS register can be used to determine the cause of device reset. The $\overline{\text{PD}}$ bit, which is set on power-up, is cleared when SLEEP is invoked. The $\overline{\text{TO}}$ bit is cleared if a WDT time-out occurred (and caused wake-up).

The following peripheral interrupts can wake the device from SLEEP:

- 1. TMR1 interrupt. Timer1 must be operating as an asynchronous counter.
- 2. A/D conversion (when A/D clock source is RC).

Other peripherals cannot generate interrupts since during SLEEP, no on-chip Q clocks are present.

When the SLEEP instruction is being executed, the next instruction (PC + 1) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction after the subset (0004h). In cases where the execution of the instruction following SLEEP is not desirable, the user should have a NOP after the SLEEP instruction.

8.8.2 WAKE-UP USING INTERRUPTS

When global interrupts are disabled (GIE cleared) and any interrupt source has both its interrupt enable bit and interrupt flag bit set, one of the following will occur:

- If the interrupt occurs before the the execution of a SLEEP instruction, the SLEEP instruction will complete as a NOP. Therefore, the WDT and WDT postscaler will not be cleared, the TO bit will not be set and PD bits will not be cleared.
- If the interrupt occurs during or after the execution of a SLEEP instruction, the device will immediately wake up from sleep. The SLEEP instruction will be completely executed before the wake-up. Therefore, the WDT and WDT postscaler will be cleared, the TO bit will be set and the PD bit will be cleared.

Even if the flag bits were checked before executing a SLEEP instruction, it may be possible for flag bits to become set before the SLEEP instruction completes. To determine whether a SLEEP instruction executed, test the \overline{PD} bit. If the \overline{PD} bit is set, the SLEEP instruction was executed as a NOP.

To ensure that the WDT is cleared, a CLRWDT instruction should be executed before a SLEEP instruction.

TABLE 9-2: PIC16CXX INSTRUCTION SET

Mnemonic,		Description	Cycles		14-Bit Opcode		Status	Notes		
Operands				MSb			LSb	Affected		
BYTE-ORIENTED FILE REGISTER OPERATIONS										
ADDWF	f, d	Add W and f	1	00	0111	dfff	ffff	C,DC,Z	1,2	
ANDWF	f, d	AND W with f	1	00	0101	dfff	ffff	Z	1,2	
CLRF	f	Clear f	1	00	0001	lfff	ffff	Z	2	
CLRW	-	Clear W	1	00	0001	0xxx	xxxx	Z		
COMF	f, d	Complement f	1	00	1001	dfff	ffff	Z	1,2	
DECF	f, d	Decrement f	1	00	0011	dfff	ffff	Z	1,2	
DECFSZ	f, d	Decrement f, Skip if 0	1(2)	00	1011	dfff	ffff		1,2,3	
INCF	f, d	Increment f	1	00	1010	dfff	ffff	Z	1,2	
INCFSZ	f, d	Increment f, Skip if 0	1(2)	00	1111	dfff	ffff		1,2,3	
IORWF	f, d	Inclusive OR W with f	1	00	0100	dfff	ffff	Z	1,2	
MOVF	f, d	Move f	1	00	1000	dfff	ffff	Z	1,2	
MOVWF	f	Move W to f	1	00	0000	lfff	ffff			
NOP	-	No Operation	1	00	0000	0xx0	0000			
RLF	f, d	Rotate Left f through Carry	1	00	1101	dfff	ffff	С	1,2	
RRF	f, d	Rotate Right f through Carry	1	00	1100	dfff	ffff	С	1,2	
SUBWF	f, d	Subtract W from f	1	00	0010	dfff	ffff	C,DC,Z	1,2	
SWAPF	f, d	Swap nibbles in f	1	00	1110	dfff	ffff		1,2	
XORWF	f, d	Exclusive OR W with f	1	00	0110	dfff	ffff	Z	1,2	
BIT-ORIENT	ED FIL	E REGISTER OPERATIONS						-		
BCF	f, b	Bit Clear f	1	01	00bb	bfff	ffff		1,2	
BSF	f, b	Bit Set f	1	01	01bb	bfff	ffff		1,2	
BTFSC	f, b	Bit Test f, Skip if Clear	1 (2)	01	10bb	bfff	ffff		3	
BTFSS	f, b	Bit Test f, Skip if Set	1 (2)	01	11bb	bfff	ffff		3	
LITERAL A	ND CO	NTROL OPERATIONS								
ADDLW	k	Add literal and W	1	11	111x	kkkk	kkkk	C,DC,Z		
ANDLW	k	AND literal with W	1	11	1001	kkkk	kkkk	Z		
CALL	k	Call subroutine	2	10	0kkk	kkkk	kkkk			
CLRWDT	-	Clear Watchdog Timer	1	00	0000	0110	0100	TO,PD		
GOTO	k	Go to address	2	10	1kkk	kkkk	kkkk			
IORLW	k	Inclusive OR literal with W	1	11	1000	kkkk	kkkk	Z		
MOVLW	k	Move literal to W	1	11	00xx	kkkk	kkkk			
RETFIE	-	Return from interrupt	2	00	0000	0000	1001			
RETLW	k	Return with literal in W	2	11	01xx	kkkk	kkkk			
RETURN	-	Return from Subroutine	2	00	0000	0000	1000			
SLEEP	-	Go into standby mode	1	00	0000	0110	0011	TO,PD		
SUBLW	k	Subtract W from literal	1	11	110x	kkkk	kkkk	C,DC,Z		
XORLW	k	Exclusive OR literal with W	1	11	1010	kkkk	kkkk	Z		

Note 1: When an I/O register is modified as a function of itself (e.g., MOVF PORTB, 1), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned to the Timer0 Module.

3: If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

Inclusive OR W with f							
[label]	IORWF	f,d					
$0 \le f \le 127$ $d \in [0,1]$							
(W) .OR. (f) \rightarrow (dest)							
Z							
00	0100	dfff	ffff				
Inclusive OR the W register with regis- ter 'f'. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.							
1							
1							
Q1	Q2	Q3	Q4				
Decode	Read register 'f'	Process data	Write to dest				
IORWF		RESULT,	0				
Before In	struction	1					
RESULT = 0x13 $W = 0x01$							
After Instruction							
	RESULT = 0x13						
	W = 0x93 7 - 1						
	Inclusive [label] $0 \le f \le 12$ $d \in [0,1]$ (W) .OR. \overline{Z} Inclusive C ter 'f'. If 'd' the W reginst placed base 1 1 Q1 Decode IORWF Before In After Inst	Inclusive OR Wy $[label]$ IORWF $0 \le f \le 127$ $d \in [0,1]$ (W) .OR. $(f) \rightarrow (de)$ \overline{Z} 00 0100Inclusive OR the Wter 'f'. If 'd' is 0 the rethe W register. If 'd'placed back in regist1Q1Q2DecodeReadregister'f'IORWFBefore InstructionRESULTWAfter InstructionRESULTW7	Inclusive OR W with f[label]IORWFf,d $0 \le f \le 127$ $d \in [0,1]$ (W) .OR. $(f) \rightarrow (dest)$ \overline{Z} 00 0100dfffInclusive OR the W register witter 'f'. If 'd' is 0 the result is platthe W register. If 'd' is 1 the result placed back in register 'f'.11Q1Q2Q3DecodeRead register 'f'IORWFRESULT ,Before Instruction RESULT = 0x13 W = 0x91After Instruction RESULT = 0x13 W = 0x93 Z = 1				

MOVLW	Move Lit	eral to V	v	
Syntax:	[label]	MOVLW	/ k	
Operands:	$0 \le k \le 28$	55		
Operation:	$k\to(W)$			
Status Affected:	None			
Encoding:	11	00xx	kkkk	kkkk
Description:	The eight register. Th as 0's.	bit literal ' ne don't c	k' is loaded ares will as	d into W ssemble
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read literal 'k'	Process data	Write to W
Example	MOVLW After Inst	0x5A		
		W =	0x5A	

MOVF	Move f							
Syntax:	[label] MOVF f,d							
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \ [0,1] \end{array}$							
Operation:	$(f) \rightarrow (dest)$							
Status Affected:	Z							
Encoding:	00 1000 dfff ffff							
Description:	The contents of register f is moved to a destination dependant upon the sta- tus of d. If $d = 0$, destination is W reg- ister. If $d = 1$, the destination is file register f itself. $d = 1$ is useful to test a file register since status flag Z is affected.							
Words:	1							
Cycles:	1							
Q Cycle Activity:	Q1 Q2 Q3 Q4							
	Decode Read Process Write to register data dest							
Example	MOVF FSR, 0							
	After Instruction W = value in FSR register Z = 1							

MOVWF	Move W	to f		
Syntax:	[label]	MOVW	F f	
Operands:	$0 \le f \le 12$	27		
Operation:	$(W) \rightarrow (f)$)		
Status Affected:	None			
Encoding:	00	0000	lfff	ffff
Description:	Move data 'f'.	from W r	egister to	register
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write register 'f'
Example	MOVWF	OPTIC	ON_REG	
	Before In	struction	1	
			= 0xFI	=
	After Inst	ruction	- 0,41	
		OPTION	= 0x4	=
		W	= 0x4F	=

	PIC12C5XX	PIC14000	PIC16C5X	PIC16CXXX	PIC16C6X	PIC16C7XX	PIC16C8X	PIC16C9XX	PIC17C4X	PIC17C75X	24CXX 25CXX 93CXX	HCS200 HCS300 HCS301
BICMASTER®/ PICMASTER-CE In-Circuit Emulator	2	7	7	7	>	7	2	2	>	Available 3Q97		
ICEPIC Low-Cost In-Circuit Emulator	7		7	7	7	7	7					
MPLAB™ Integrated Development Environment	7	7	7	7	7	7	7	7	7	7		
MPLAB™ C S Compiler	7	7	7	7	7	7	2	2	7	7		
fuzz/TECH®-MP Explorer/Edition Fuzzy Logic Dev. Tool	7	7	2	2	7	7	2	2	2			
MP-DriveWay™ Applications Code Generator			7	7	7	7	7		7			
Total Endurance™ Software Model											2	
PICSTART® Lite Ultra Low-Cost Dev. Kit			7		2	7	2					
C PICSTART® Plus Low-Cost Universal Dev. Kit	7	2	7	7	>	7	2	>	~	7		
면 PRO MATE® II Universal Programmer	7	7	7	7	7	7	2	7	7	7	7	7
KEELOQ [®] Programmer												7
SEEVAL [®] Designers Kit											7	
PICDEM-1			2	7			7		7			
DICDEM-2					7	7						
BICDEM-3								2				
KEELOQ [®] Evaluation Kit												7

TABLE 10-1: DEVELOPMENT TOOLS FROM MICROCHIP

Applicable Devices 710 71 711 715

FIGURE 11-7: A/D CONVERSION TIMING



TABLE 11-7: A/D CONVERSION REQUIREMENTS

Param No.	Sym	Characteristic		Min	Тур†	Мах	Units	Conditions
130	TAD	A/D clock period	PIC16 C 710/711	1.6	_	_	μs	Tosc based, VREF ≥ 3.0V
			PIC16 LC 710/711	2.0	_	_	μs	Tosc based, VREF full range
			PIC16 C 710/711	2.0*	4.0	6.0	μs	A/D RC mode
			PIC16 LC 710/711	3.0*	6.0	9.0	μs	A/D RC mode
131	TCNV	Conversion time (not including S/H time). (Note 1)		—	9.5	_	TAD	
132	TACQ	Acquisition time		Note 2	20	_	μs	
				5*	_	_	μs	The minimum time is the amplifier settling time. This may be used if the "new" input voltage has not changed by more than 1 LSb (i.e., 19.5 mV @ 5.12V) from the last sampled voltage (as stated on CHOLD).
134	TGO	Q4 to AD clock sta	art	_	Tosc/2§		_	If the A/D clock source is selected as RC, a time of TCY is added before the A/D clock starts. This allows the SLEEP instruction to be executed.
135	Tswc	Switching from co	nvert \rightarrow sample time	1.5§	_	—	TAD	

These parameters are characterized but not tested.

Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not t tested.

This specification ensured by design. §

Note 1: ADRES register may be read on the following TCY cycle.

2: See Section 7.1 for min conditions.

Applicable Devices 710 71 711 715

13.4 <u>Timing Parameter Symbology</u>

The timing parameter symbols have been created following one of the following formats:

- 1. TppS2ppS
- 2. TppS



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TABLE 13-5: TIMER0 CLOCK REQUIREMENTS

Param No.	Sym	Characteristic		Min	Тур†	Max	Units	Conditions
40	Tt0H	T0CKI High Pulse Width	No Prescaler	0.5TCY + 20*		_	ns	
			With Prescaler	10*	[—	—	ns	
41	Tt0L	T0CKI Low Pulse Width	No Prescaler	0.5TCY + 20*	-	_	ns	
			With Prescaler	10*	-	_	ns	
42	Tt0P	T0CKI Period		Greater of: 20µs or <u>Tcy + 40</u> * N	_	_	ns	N = prescale value (1, 2, 4,, 256)
48	Tcke2tmrl	Delay from external clock edge	to timer increment	2Tosc	—	7Tosc	—	

- * These parameters are characterized but not tested. \checkmark
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.



20 MHz

DS30272A-page 132

± 30 PPM

EPSON CA-301 20.000M-C

6.0

Applicable Devices 710 71 711 715							
15.3	DC Characteristics: PIC16C71 PIC16C71 PIC16LC7 PIC16LC7	-04 (0 -20 (0 1-04 (0	Commerc Commerc Commerc	cial, cial, cial,	Indust Indust Indust	rial) rial) rial)	
		Standa	rd Opera	ting	Conditi	ons (u	nless otherwise stated)
		OOpera	ating temp	erat	ure 0°C	≤	$TA \leq +70^{\circ}C$ (commercial)
DC CHA	RACTERISTICS	•		\/-	-40°	C _≤	$IA \leq +85^{\circ}C$ (industrial)
		Operation operation	ng voltage	e vd	D range	as des	cribed in DC spec Section 15.1
Daram	Characteristic		Min	Tvn	Max	Unite	Conditions
No.	Gharacteristic	Sym		1 1	WIAN	Units	Conditions
	Input Low Voltage						
	I/O ports	VIL					
D030	with TTL buffer		Vss	-	0.15V	V	For entire VDD range
D031	with Schmitt Trigger buffer		Vss	-	0.8V	V	$4.5 \le VDD \le 5.5V$
D032	MCLR, OSC1 (in RC mode)		Vss	-	0.2Vdd	V	
D033	OSC1 (in XT, HS and LP)		Vss	-	0.3Vdd	V	Note1
	Input High Voltage						
	I/O ports (Note 4)	Vін		-			
D040	with TTL buffer		2.0	-	Vdd	V	$4.5 \le VDD \le 5.5V$
D040A			0.25VDD + 0.8V	-	Vdd		For entire VDD range
D041	with Schmitt Trigger buffer		0.85Vdd	-	Vdd		For entire VDD range
D042	MCLR, RB0/INT		0.85Vdd	-	Vdd	V	
D042A	OSC1 (XT, HS and LP)		0.7Vdd	-	Vdd	V	Note1
D043	OSC1 (in RC mode)		0.9Vdd	-	Vdd	V	
D070	PORTB weak pull-up current	IPURB	50	250	†400	μΑ	VDD = 5V, VPIN = VSS
	Input Leakage Current (Notes 2, 3)						
D060	I/O ports	lı∟	-	-	±1	μA	Vss \leq VPIN \leq VDD, Pin at hi- impedance
D061	MCLR, RA4/T0CKI		-	-	±5	μΑ	$Vss \le VPIN \le VDD$
D063	OSC1		-	-	±5	μA	Vss \leq VPIN \leq VDD, XT, HS and LP osc configuration
	Output Low Voltage						
D080	I/O ports	Vol	-	-	0.6	V	IOL = 8.5mA, VDD = 4.5V, -40°C to +85°C
D083	OSC2/CLKOUT (RC osc config)		-	-	0.6	V	IOL = 1.6mA, VDD = 4.5V, -40°C to +85°C
	Output High Voltage						
D090	I/O ports (Note 3)	Vон	VDD - 0.7	-	-	V	IOH = -3.0mA, VDD = 4.5V, -40°С to +85°С
D092	OSC2/CLKOUT (RC osc config)		Vdd - 0.7	-	-	V	IOH = -1.3mA, VDD = 4.5V, -40°С to +85°С
D130*	Open-Drain High Voltage	Vod	-	-	14	V	RA4 pin
·			· · · ·				

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1 pin is a Schmitt trigger input. It is not recommended that the PIC16C71 be driven with external clock in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
 2: Negative current is defined as current sourced by the pin.

3: Negative current is defined as current sourced by the pin.

4: PIC16C71 Rev. "Ax" INT pin has a TTL input buffer. PIC16C71 Rev. "Bx" INT pin has a Schmitt Trigger input buffer.





FIGURE 16-18: TRANSCONDUCTANCE (gm) OF XT OSCILLATOR vs. VDD







Data based on matrix samples. See first page of this section for details.

LIST OF TABLES

Table 1-1: Table 3-1	PIC16C71X Family of Devices	4
	Description	9
Table 4-1:	PIC16C710/71/711 Special Function	14
Table 4-2:	PIC16C715 Special Function Register	. 14
	Summary	. 15
Table 5-1:	PORTA Functions	. 26
Table 5-2:	PORTA	. 26
Table 5-3:	PORTB Functions	. 28
Table 5-4:	Summary of Registers Associated with	20
Table 6-1:	Registers Associated with Timer0	. 29
Table 7-1:	TAD vs. Device Operating Frequencies,	
	PIC16C71	. 41
Table 7-2:	TAD vs. Device Operating Frequencies,	11
Table 7-3	Registers/Bits Associated with A/D	. 41
	PIC16C710/71/711	. 46
Table 7-4:	Registers/Bits Associated with A/D,	
T 1 1 0 4	PIC16C715	. 46
Table 8-1:	Ceramic Resonators, PIC16C/1	. 49
	Oscillator PIC16C71	49
Table 8-3:	Ceramic Resonators.	. 40
	PIC16C710/711/715	. 50
Table 8-4:	Capacitor Selection for Crystal	
Table 0 C	Oscillator, PIC16C/10//11//15	. 50
Table 8-5:	PIC16C71	. 54
Table 8-6:	Time-out in Various Situations,	
Table 0.7	PIC16C710/711/715	. 54
Table 8-7:	PIC16C71	.55
Table 8-8:	Status Bits and Their Significance,	
	PIC16C710/711	. 55
Table 8-9:	Status Bits and Their Significance,	55
Table 8-10:	Reset Condition for Special Registers,	. 00
	PIC16C710/71/711	. 56
Table 8-11:	Reset Condition for Special Registers,	56
Table 8-12:	Initialization Conditions For All Registers.	. 50
	PIC16C710/71/711	. 57
Table 8-13:	Initialization Conditions for All Registers,	
	PIC16C715	. 58
	PIC16CXX Instruction Set	. 69
Table 10-1	Development Tools From Microchip	. 70 88
Table 11-1:	Cross Reference of Device Specs for	
	Oscillator Configurations and	
	Frequencies of Operation	_
T-11- 11-0	(Commercial Devices)	. 89
Table 11-2:	External Clock Timing Requirements	. 95
Table 11-3:	CLKOUT and I/O Timing Requirements	. 96
	Start-up Timer, Power-up Timer,	
	and Brown-out Reset Requirements	. 97
Table 11-5:	Timer0 External Clock Requirements	. 98

Table 11-6:	A/D Converter Characteristics:
	PIC16C710/711-04
	(Commercial, Industrial, Extended)
	PIC16C710/711-10
	(Commercial, Industrial, Extended)
	PIC16C710/711-20
	(Commercial, Industrial, Extended)
	PIC16LC710/711-04
	(Commercial, Industrial, Extended)99
Table 11-7:	A/D Conversion Requirements 100
Table 12-1:	RC Oscillator Frequencies 107
Table 12-2:	Capacitor Selection for Crystal
	Oscillators 108
Table 13-1:	Cross Reference of Device Specs for
	Oscillator Configurations and
	Frequencies of Operation
	(Commercial Devices) 112
Table 13-2:	Clock Timing Requirements 118
Table 13-3:	CLKOUT and I/O Timing Requirements . 119
Table 13-4:	Reset, Watchdog Timer, Oscillator
	Start-up Timer, Power-up Timer,
	and Brown-out Reset Requirements 120
Table 13-5:	Timer0 Clock Requirements 121
Table 13-6:	A/D Converter Characteristics:
	PIC16C715-04
	(Commercial, Industrial, Extended)
	PIC16C715-10
	(Commercial, Industrial, Extended)
	(Commercial, Industrial, Extended) PIC16C715-20
	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) 122
Table 13-7:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) 122 A/D Converter Characteristics:
Table 13-7:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) 122 A/D Converter Characteristics: PIC16LC715-04 (Commercial,
Table 13-7:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) 122 A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial) 123
Table 13-7: Table 13-8:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) 122 A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial) 123 A/D Conversion Requirements
Table 13-7: Table 13-8: Table 14-1:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) 122 A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial) 123 A/D Conversion Requirements
Table 13-7: Table 13-8: Table 14-1: Table 14-2:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) 122 A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial) 123 A/D Conversion Requirements
Table 13-7: Table 13-8: Table 14-1: Table 14-2:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) 122 A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial)
Table 13-7: Table 13-8: Table 14-1: Table 14-2: Table 15-1:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) 122 A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial)
Table 13-7: Table 13-8: Table 14-1: Table 14-2: Table 15-1:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) 122 A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial)
Table 13-7: Table 13-8: Table 14-1: Table 14-2: Table 15-1:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) 122 A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial)
Table 13-7: Table 13-8: Table 14-1: Table 14-2: Table 15-1:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial) 123 A/D Conversion Requirements 124 RC Oscillator Frequencies 131 Capacitor Selection for Crystal Oscillators 132 Cross Reference of Device Specs for Oscillator Configurations and Frequencies of Operation (Commercial Devices) 135
Table 13-7: Table 13-8: Table 14-1: Table 14-2: Table 15-1:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial) 123 A/D Conversion Requirements 124 RC Oscillator Frequencies 131 Capacitor Selection for Crystal Oscillators 132 Cross Reference of Device Specs for Oscillator Configurations and Frequencies of Operation (Commercial Devices) 135 External Clock Timing Requirements
Table 13-7: Table 13-8: Table 14-1: Table 14-2: Table 15-1: Table 15-2: Table 15-2: Table 15-3:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial) 123 A/D Conversion Requirements 124 RC Oscillator Frequencies 131 Capacitor Selection for Crystal Oscillators 132 Cross Reference of Device Specs for Oscillator Configurations and Frequencies of Operation (Commercial Devices) 135 External Clock Timing Requirements 141 CLKOUT and I/O Timing Requirements
Table 13-7: Table 13-8: Table 14-1: Table 14-2: Table 15-1: Table 15-2: Table 15-3: Table 15-4:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) 122 A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial)
Table 13-7: Table 13-8: Table 14-1: Table 14-2: Table 15-1: Table 15-2: Table 15-3: Table 15-4:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial) Industrial) 123 A/D Conversion Requirements 124 RC Oscillator Frequencies 131 Capacitor Selection for Crystal Oscillators 0scillator Configurations and Frequencies of Operation (Commercial Devices) 135 External Clock Timing Requirements 141 CLKOUT and I/O Timing Requirements 142 Reset, Watchdog Timer, Oscillator Start-up Timer and Power-up Timer
Table 13-7: Table 13-8: Table 14-1: Table 14-2: Table 15-1: Table 15-2: Table 15-3: Table 15-4:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial) 123 A/D Conversion Requirements 124 RC Oscillator Frequencies 131 Capacitor Selection for Crystal Oscillators 132 Cross Reference of Device Specs for Oscillator Configurations and Frequencies of Operation (Commercial Devices) 135 External Clock Timing Requirements 141 CLKOUT and I/O Timing Requirements 142 Reset, Watchdog Timer, Oscillator Start-up Timer and Power-up Timer Requirements
Table 13-7: Table 13-8: Table 14-1: Table 14-2: Table 15-1: Table 15-2: Table 15-3: Table 15-4:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) 122 A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial)
Table 13-7: Table 13-8: Table 14-1: Table 14-2: Table 15-1: Table 15-2: Table 15-3: Table 15-4: Table 15-5: Table 15-6:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial) 123 A/D Conversion Requirements 124 RC Oscillator Frequencies 131 Capacitor Selection for Crystal 0scillators Oscillator Configurations and 132 Frequencies of Operation 135 External Clock Timing Requirements 141 CLKOUT and I/O Timing Requirements 142 Reset, Watchdog Timer, Oscillator Start-up Timer and Power-up Timer Requirements 143 Timer0 External Clock Requirements 144 A/D Converter Characteristics 145
Table 13-7: Table 13-8: Table 14-1: Table 14-2: Table 15-1: Table 15-2: Table 15-3: Table 15-4: Table 15-5: Table 15-6: Table 15-7:	(Commercial, Industrial, Extended) PIC16C715-20 (Commercial, Industrial, Extended) A/D Converter Characteristics: PIC16LC715-04 (Commercial, Industrial) Industrial) 123 A/D Conversion Requirements 124 RC Oscillator Frequencies 131 Capacitor Selection for Crystal Oscillators 132 Cross Reference of Device Specs for Oscillator Configurations and Frequencies of Operation (Commercial Devices) 135 External Clock Timing Requirements 141 CLKOUT and I/O Timing Requirements 142 Reset, Watchdog Timer, Oscillator Start-up Timer and Power-up Timer Requirements 143 Timer0 External Clock Requirements 144 A/D Converter Characteristics 145 A/D Conversion Requirements 146

NOTES:

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